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RECORDATION
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To the Director of the U.S. Patent and Trademark Office, please forward this document to the address(es) below.

1. Name of conveying party(ies):
Jeff Viens

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: MICRON TECHNOLOGY, INC.

Internal Address: _____

Street Address: _____

8000 S. Federal Way

City: Boise

State: Idaho

Country: United States of America Zip: 83716-9632

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): June 5, 2008

Assignment Merger Change of Name

Security Agreement Joint Research Agreement

Government Interest Assignment

Executive Order 9424, Confirmatory License

Other _____

4. Application or patent number(s):

A. Patent Application No.(s)

This application

This document is being filed together with a new application.

B. Patent No.(s)

12/213562

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Thomas J. D'Amico
DICKSTEIN SHAPIRO LLP

Internal Address: Atty. Dkt.: M4065.1494/P1494

Street Address: 1825 Eye Street, NW

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6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

Authorized to be charged by credit card

Authorized to be charged to deposit account

Enclosed

None required (government interest not affecting title)

8. Payment Information

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9. Signature:

Signature

June 20, 2008

Date

Thomas J. D'Amico - 28,371

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

06/23/2008 JADD01

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ASSIGNMENT AND AGREEMENT

For value received, I, Jeff Viens, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled EMBEDDED LENS FOR ACHROMATIC WAFER-LEVEL OPTICAL MODULE AND METHODS OF FORMING THE SAME, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

Docket No.: M4065.1494/P1494

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Jeff Viens
Jeff Viens

Date: 06/05/2008

United States of America)
State of DC) ss.:
County of Charles County

On this 05 day of June, 2008, before me personally came Jeff Viens, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.

[Signature]
Notary Public

